





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.:

Lamson et al. 09/989,263

Art Unit:

2823

11/19/01

Examiner:

Maldonado, J.

Teletion Tomanida 1/26/02

Filed: 11/19

Docket:

TI-31189

For:

LOW CAPACITANCE COUPLING WIRE BONDED SEMICONDUCTOR

DEVICE

ELECTION

July 9, 2002

Commissioner of Patents and Trademarks Washington, D.C. 20231 MAILING CERTIFICATE UNDER 37 C.F.R. 1.8 (A)

I hereby certify that the above correspondence is being deposited with the U.S. For Service as First Class Mail in an envelope addressed to: Commissioner of Patents at Trademarks, Washington, D.C. 20231 on July 9, 2002.

Ginger Cox

Sir:

Responsive to the Office Action dated June 18, 2002, please enter the following:

For prosecution, Applicants elect Group I, Claims 1-16, drawn to a semiconductor device, classified in class 257, subclass 687.

Applicants acknowledge that Claim 17 is withdrawn from further examination.

A prompt action on the merits is respectfully requested.

Respectfully Submitted,

Gary Q. Honeycutt

Reg. No. 20,250 / Attorney for Applicant

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Commissioner of Patents and Trademarks Washington, D.C. 20231

Re:

Patent Application for:

"LOW CAPACITANCE COUPLING WIRE BONDED

July 9, 2002

SEMICONDUCTOR DEVICE"

Serial No.:

09/989,263

Attorney Docket:

TI-31189

Our File:

50000.2163

Dear Sir:

Enclosed for filing please find the following items relating to the above-identified application:

- (1) Election Document; and
- (2) Postcards.

Please file the above documents and return the date-stamped postcards to the corresponding addresses, as indicated. In the meantime, if you have any questions or comments concerning this matter, please call the undersigned. Otherwise, please accept the enclosed.

Respectfully submitted,

Gary/C. Honeyoutt

Reg. No. 20,250

GCH:glc

Enclosures

cc: James Brady, III (Texas Instruments, w/ encls.)